

High Power RF GaN Amplifier

640 W, 48 V, 2620 - 2690 MHz



MACOM PURE CARBIDE

MAPC-C27640-DP

Rev. V1

Features

- GaN on SiC HEMT Technology
- Designed for Asymmetrical Doherty Application
- 49.3 dBm Average Output Power
- 640 W Peak Output Power
- Input and Output Pre-matched Device
- Low Thermal Resistance
- 100% DC and RF Tested
- RoHS* Compliant

Description

The MAPC-C27640-DP is a GaN on Silicon Carbide HEMT Amplifier designed for asymmetrical Doherty applications. The device is optimized for the frequency band of 2620 to 2690 MHz. Product is housed in an over-molded TO-package.



TO-248-4/2

Typical Doherty Performance:

$V_{DS} = 50 \text{ V}$, $I_{DQm} = 250 \text{ mA}$, $V_{GSpk} = 500\text{mA} - 1.9\text{V}$
 $P_{OUT} = 49.3 \text{ dBm}$, $T_a = 25^\circ\text{C}$

Frequency (MHz)	Gain (dB)	Efficiency (%)	Output PAR (dB)	ACPR (dBc)
2620	15.1	53.8	7.8	-30.1
2655	15.2	54.1	7.9	-28.9
2690	15.3	54.6	7.9	-27.5

Note:

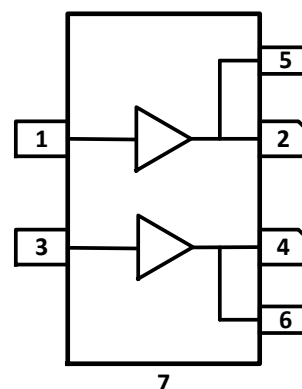
Performance in MACOM Doherty Application Fixture. Single Carrier W-CDMA Channel Bandwidth 3.84 MHz, PAR 10 dB @ 0.01% CCDF.

Ordering Information

Part Number	Package
MAPC-C27640-DPTR1	50 pc Tape and Reel ¹
MAPC-C27640-DPTR2	250 pc Tape and Reel ¹
MAPC-C27640-DPSB1	Sample Board

1. See application note AN-0004525 for tape & reel information.

Functional Schematic



Pin Configuration

Pin #	Pin Name	Function
1	RF _{IN} / V _{G1}	RF Input / Gate (Main)
2	RF _{OUT} / V _{D1}	RF Output / Drain (Main)
3	RF _{IN} / V _{G2}	RF Input / Gate (Peak)
4	RF _{OUT} / V _{D2}	RF Output / Drain (Peak)
5, 6	VBW Lead	Drain Video Decoupling. No DC Bias
7	Flange ²	Ground / Source

2. The flange on the package bottom must be connected to RF, DC and thermal ground.

1 * Restrictions on Hazardous Substances, compliant to current RoHS EU directive.

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RF Electrical Characterization:

Freq. = 2690 MHz, P_{OUT} = 49.3 dBm, T_A = 25°C, V_{DS} = 50 V, I_{DQM} = 250 mA, V_{GSPK} = 500 mA - 1.9 V

Performance in MACOM Doherty Application Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84 MHz, PAR 10dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	—	G _p	—	15.3	—	dB
Drain Efficiency	—	η	—	55	—	%
Output CCDF @ 0.01%	—	PAR	—	7.9	—	dB
Adjacent Channel Power	—	ACP	—	-27.5	—	dBc
Input Return Loss	—	IRL	—	-18	—	dB
Gain Flatness	—	G _F	—	0.3	—	dB
Gain Variation (-40°C to +125°C)	2690 MHz, -40°C to +125°C	ΔG	—	0.02	—	dB/°C
Power Variation (-40°C to +125°C)	2690 MHz, -40°C to +125°C	ΔP _{3dB}	—	0.004	—	dB/°C
Ruggedness: Output Mismatch	All phase angles	Ψ	VSWR =10:1, No Device Damage			

RF Electrical Test Specifications:

P_{OUT} = 49.3 dBm, T_A = 25°C, V_{DS} = 50 V, I_{DQM} = 250 mA, V_{GSPK} = 500mA - 1.7V

Note: Performance in MACOM Doherty Production Test Fixture. Single Carrier- W-CDMA Channel Bandwidth 3.84 MHz, PAR 10dB @ 0.01% CCDF.

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Power Gain	2620 MHz 2690 MHz	G _p	12.8 12.8	14.0 13.9	—	dB
Drain Efficiency	2620 MHz 2690 MHz	η	45.0 45.0	53.7 53.7	—	%
Output CCDF @ 0.01%	2620 MHz 2690 MHz	PAR	6.5 5.5	7.4 6.7	—	dB
Adjacent Channel Power	2620 MHz 2690 MHz	ACP	—	-26.6 -25.7	-17.0 -17.0	dBc

DC Electrical Characteristics $T_A = 25^\circ\text{C}$

Parameter	Test Conditions	Symbol	Min.	Typ.	Max.	Units
Main Amplifier						
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	I_{DLK}	—	—	3.5	mA
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 100\text{ V}$	I_{DLK}	—	—	4.5	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	I_{GLK}	-3.5	—	—	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 100\text{ V}$	I_{GLK}	-3.0	—	—	mA
Gate Threshold Voltage	$V_{DS} = 10\text{ V}, I_D = 25\text{ mA}$	V_T	-3.5	-2.2	-1.7	V
Peak Amplifier						
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	I_{DLK}	—	—	7.0	mA
Drain-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 100\text{ V}$	I_{DLK}	—	—	14.1	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 10\text{ V}$	I_{GLK}	-7.0	—	—	mA
Gate-Source Leakage Current	$V_{GS} = -8\text{ V}, V_{DS} = 100\text{ V}$	I_{GLK}	-6.1	—	—	mA
Gate Threshold Voltage	$V_{DS} = 10\text{ V}, I_D = 50\text{ mA}$	V_T	-3.5	-2.2	-1.7	V

Recommended Operating Voltages

Parameter	Test Conditions	Units	Min.	Typ.	Max.
Drain Operating Voltage	—	V	—	50	—
Gate Quiescent Voltage	$V_{DS} = 48\text{ V}, I_D = 250\text{ mA}$	V	-3.5	-2.2	-1.9

Absolute Maximum Ratings^{3,4,5,6,7}

Parameter	Absolute Maximum
Drain Source Voltage, V_{DS}	100 V
Operating Voltage, V_{DS}	55 V
Gate Source Voltage, V_{GS}	-10 to 2 V
Gate Current (Main), I_G	25 mA
Gate Current (Peak), I_G	50 mA
Storage Temperature Range	-65°C to +150°C
Case Operating Temperature Range	-40°C to +125°C
Channel Operating Temperature Range, T_{CH}	-40°C to +225°C
Absolute Maximum Channel Temperature	+225°C

3. Exceeding any one or combination of these limits may cause permanent damage to this device.

4. MACOM does not recommend sustained operation above maximum operating conditions.

5. Operating at drain source voltage $V_{DS} < 55V$ will ensure $MTTF > 2.51 \times 10^6$ hours.

6. Operating at nominal conditions with $T_{CH} \leq 225^\circ C$ will ensure $MTTF > 2.51 \times 10^6$ hours.

7. MTTF may be estimated by the expression $MTTF \text{ (hours)} = A e^{[B + C/(T+273)]}$ where T is the channel temperature in degrees Celsius.,
 $A = 1.93$, $B = -45.31$, and $C = 29,585$.

Thermal Characteristics⁸

Parameter	Test Conditions	Symbol	Typical	Units
Thermal Resistance using Finite Element Analysis, T_J	$P_{DISS} = 84 W$ $T_C = 116^\circ C, T_{CH} = 225^\circ C$	$R_{\theta}(FEA)$	1.3	°C/W
Thermal Resistance using Infrared Measurement of Die Surface Temperature		$R_{\theta}(IR)$	1.0	°C/W

8. Case temperature measured using thermocouple embedded in heat-sink. Contact local applications support team for more details on this measurement.

Bias Sequencing

Bias ON

1. Ensure RF is turned off
2. Apply pinch-off voltage of -5 V to the gate
3. Apply nominal drain voltage
4. Bias gate to desired quiescent drain current
5. Apply RF

Bias OFF

1. Turn RF off
2. Apply pinch-off voltage to the gate
3. Turn-off drain voltage
4. Turn-off gate voltage

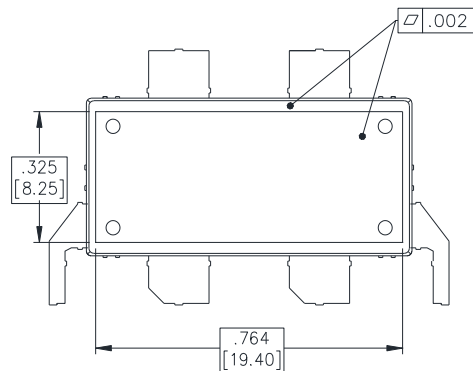
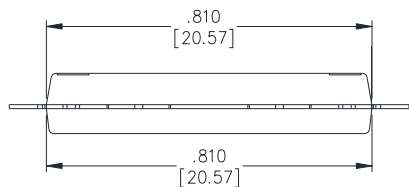
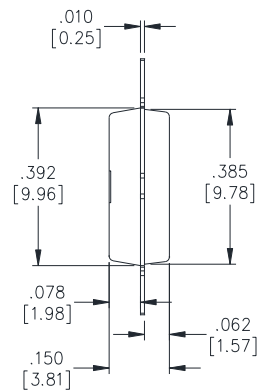
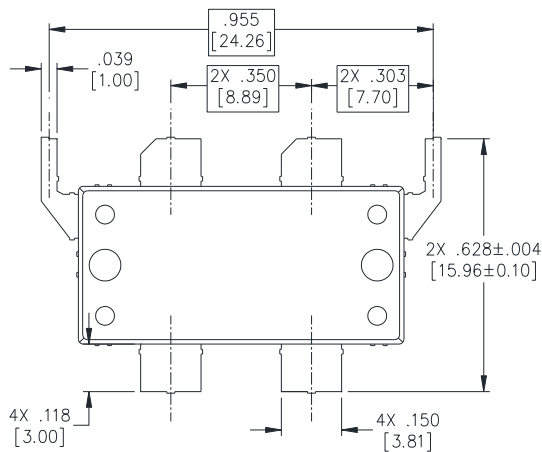
Handling Procedures

Please observe the following precautions to avoid damage:

Static Sensitivity

Gallium Nitride Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

TO-248-4/2 Package Dimensions



NOTES:

1. ALL DIMENSIONS SHOWN AS in[mm]. CONTROLLING DIMENSIONS ARE IN in AND CONVERTED mm DIMENSIONS ARE NOT NECESSARILY EXACT.
2. ALL TOLERANCES ARE ±.002 [0.05] UNLESS OTHERWISE NOTED.
3. ALL METAL SURFACES ARE MATTE Sn PLATED EXCEPT FOR CUT EDGES.
4. PACKAGE BODY AND LEAD DIMENSIONS DO NOT INCLUDE MOLD AND METAL PROTRUSIONS. ALLOWABLE PROTRUSION IS .012 [0.30] IN GENERAL AND .004 [0.10] FOR PROTRUSIONS CONNECTED TO SOURCE

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